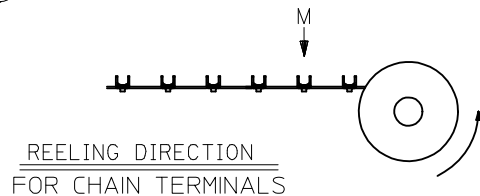


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注記
NOTES

1. 材質
MATERIAL
黄銅 (板厚: 0.3)
BRASS (THICKNESS : 0.3)
2. メッキ仕様
TERMINAL PLATING
接点部 : 金メッキ 0.25 μm MIN.
CONTACT AREA : GOLD 0.25 μm MIN.
圧着部 : 錫メッキ 1.0 μm MIN.
CRIMP AREA : TIN 1.0 μm MIN.
下地メッキ : ニッケルメッキ 2 μm MIN.
UNDER PLATE : NICKEL 2 μm MIN.
3. 適用電線範囲: UL 1015, AWG #18~14
APPLICABLE WIRE RANGE : UL1015, AWG#18~14
4. 被覆外径 : φ3.8 MAX.
INSULATION EXTERNAL DIA : φ3.8 MAX.
5. 適用ハウジング: 55890-****, 55891-****
APPLICABLE HOUSING : 55890-****, 55891-****
6. 適用圧着工具 (手動) : 57413-5300 (適用電線: AWG #16~14)
APPLICABLE CRIMP TOOL (HAND) : 57413-5300 (APPLICABLE WIRE AWG #16~14)
: 57413-5400 (適用電線: AWG #18)
: 57413-5400 (APPLICABLE WIRE AWG #18)
: 63819-2200 (AWG #18-14)
7. TERMINAL EXTRACTION TOOL : 63813-2800
8. 本製品は 56193-4185 の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 56193-4185.

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CHAIN	56193-4028	56193-4***
バラ状 LOOSE	56193-4128	56193-4***
端子形状 TERMINAL CONFIGURATION	MATERIAL No.	MODEL No.

ADDED CHAIN TERM. EC NO: WNA2009-0729 DRWN: TMOELLER 2009/05/06 CHKD: RDEROSS 2009/05/07 APPR: RDEROSS 2009/05/07	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 1:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
	10 UNDER	±0.2	DRAWN BY M. NABEI	DATE '07/10/30	COMPACT ROBOT CONN. POWER CRIMP PIN -LEAD FREE- MOLEX MOLEX INCORPORATED DOCUMENT NO. SD-56193-003 SHEET NO. 1 OF 1		
	10 OVER 30 UNDER	±0.25	CHECKED BY M. ISOGAYA	DATE '07/10/30			
	30 OVER	±0.3	APPROVED BY N. UKITA	DATE '07/10/30			
ANGULAR ±3 °		MATERIAL NO.	SEE TABLE				
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				